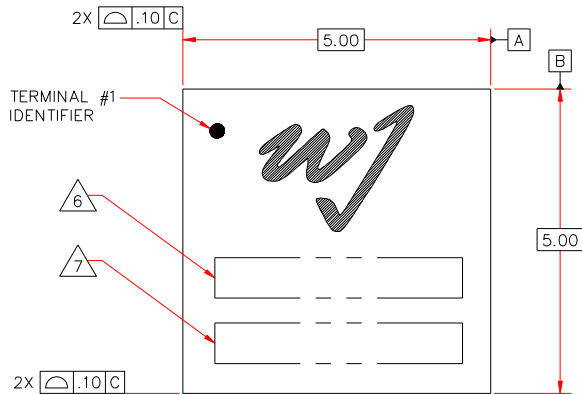




QFN 20pin 5x5mm

Package Outline Drawing



NOTES:

1. EXCEPT WHERE NOTED, THIS PART OUTLINE CONFORMS TO JEDEC STANDARD MO-220, ISSUE E (VARIATION VGGC) FOR THERMALLY ENHANCED PLASTIC VERY THIN FINE PITCH QUAD FLAT NO LEAD PACKAGE (QFN).

2. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.4M-1994.

3. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.

4 THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION CONFORM TO JESD 95-1 SPP-012.

5 COPLANARITY APPLIES TO THE EXPOSED GROUND/THERMAL PAD AS WELL AS THE TERMINALS.

6 PART NUMBER

7 ALPHA-NUMERIC LOT CODE.

